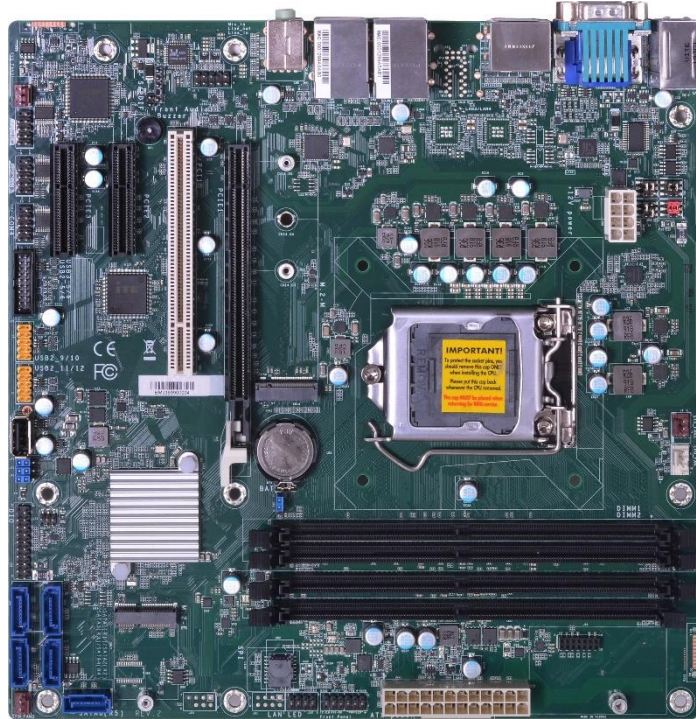




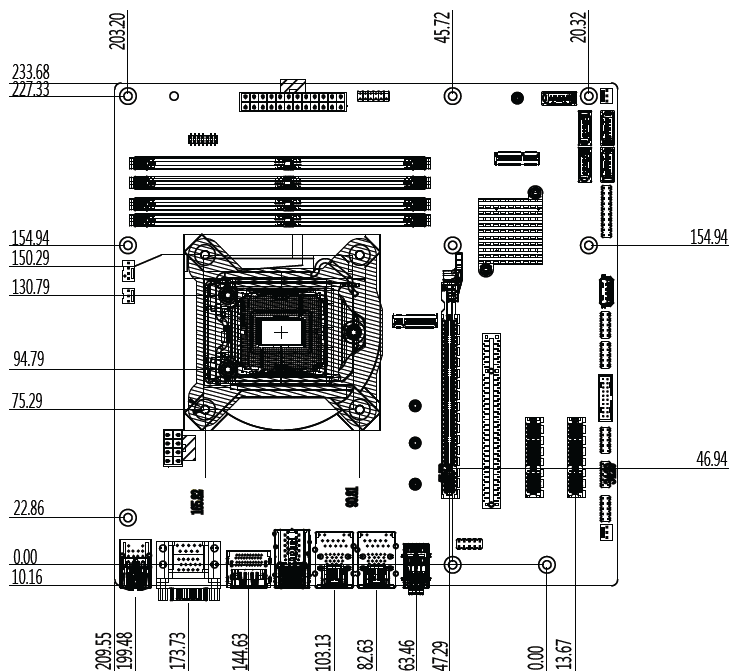
Micro ATX Industrial 8th/9th Generation Motherboard With Intel® C246 Chipset

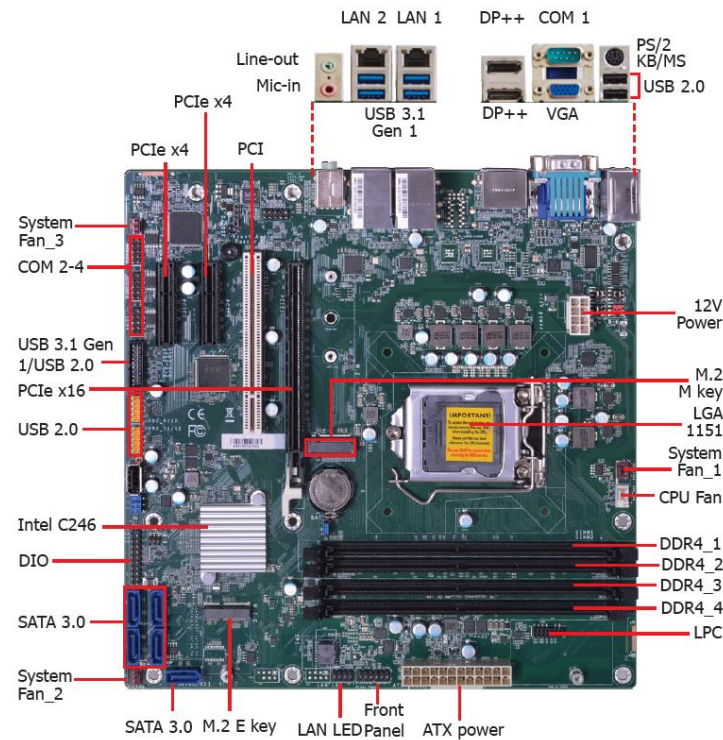
- Intel 8/9th Gen Core™ with Intel® C246
- 4 DDR4 ECC/Non-ECC DIMM up to 128GB
- Multiple expansion: 1 PCIe x16, 2 PCIe x4, 1 PCI, 1 M.2 M key, 1 x M.2 E key
- 3 independent displays: VGA + DP++ + DP++
- Rich I/O: 2 Intel GbE, 4 COM, 6 USB 3.1, 7 USB 2.0
- 15-Year CPU Life Cycle Support until Q3 '33 (Based on Intel IOTG Roadmap)

SYSTEM	PROCESSORS	8th Generation Intel® Core™ /Pentium®/Celeron® LGA 1151 Socket Processors: Intel® Xeon® E-2176G (6 Cores, 12M Cache, up to 4.7 GHz); 80W Intel® Xeon® E-2124G (4 Cores, 8M Cache, up to 4.5 GHz); 71W Intel® Core™ i7-8700K (6 Cores, 12M Cache, up to 4.7 GHz); 95W (Non-LTS) Intel® Core™ i7-8700 (6 Cores, 12M Cache, up to 4.6 GHz); 65W Intel® Core™ i7-8700T (6 Cores, 12M Cache, up to 4.0 GHz); 35W Intel® Core™ i5-8500 (6 Cores, 9M Cache, up to 4.1 GHz); 65W Intel® Core™ i5-8500T (6 Cores, 9M Cache, up to 3.5 GHz); 35W Intel® Core™ i3-8100 (4 Cores, 6M Cache, 3.6 GHz); 65W Intel® Core™ i3-8100T (4 Cores, 6M Cache, to 3.1 GHz); 35W Intel® Pentium® G5400 (2 Cores, 4M Cache, 3.7 GHz); 58W Intel® Pentium® G5400T (2 Cores, 4M Cache, 3.1 GHz); 35W Intel® Celeron® G4900 (2 Cores, 2M Cache, 3.1 GHz); 54W Intel® Celeron® G4900T (2 Cores, 2M Cache, 2.9 GHz); 35W 9th Generation Intel® Core™ LGA 1151 Socket Processors: Intel® Xeon® E-2278GEL (8 Cores, 16M Cache, up to 3.9 GHz); 35W Intel® Xeon® E-2226GE (6 Cores, 12M Cache, up to 4.6 GHz); 80W Intel® Core™ i7-9700TE (8 Cores, 12M Cache, up to 3.8 GHz); 35W Intel® Core™ i5-9500E (6 Cores, 9M Cache, up to 4.2 GHz); 65W Intel® Core™ i5-9500TE (6 Cores, 9M Cache, up to 3.6 GHz); 35W Intel® Core™ i3-9100E (4 Cores, 6M Cache, 3.7 GHz); 65W Intel® Core™ i3-9100TE (4 Cores, 6M Cache, to 3.2 GHz); 35W
	CHIPSET	Intel® C246 Chipset
	MEMORY	Four 288-pin ECC/Non-ECC DIMM up to 128GB Dual Channel DDR4 2400/2666MHz (Note: Core i5/i7 only support Non-ECC)
	BIOS	AMI SPI 128Mbit
GRAPHICS	CONTROLLER	Intel® HD Gen 9 Graphics
	FEATURE	OpenGL 4.5, DirectX 12, OpenCL 2.1 HW Decode: AVC/H.264, MPEG2, VC1/WMV9, JPEG/MJPEG, HEVC/H265, VP8, VP9 HW Encode: MPEG2, AVC/H264, JPEG, HEVC/H265, VP8, VP9
	DISPLAY	1 x VGA 2 x DP++ VGA: resolution up to 1920x1200 @ 60Hz DP++: resolution up to 4096x2106 @ 60Hz
EXPANSION	TRIPLE DISPLAYS	VGA + DP++ + DP++
	INTERFACE	1 x PCIe x16 (Gen 3) 2 x PCIe x4 (Gen 3) 1 x PCI 1 x M.2 2242/2280 M key (PCIe Gen3 x 4 NVMe/Intel Optane Memory Support) 1 x M.2 2230 E key (PCIe x1/USB2.0)
AUDIO	AUDIO CODEC	Realtek ALC262-VC2
ETHERNET	CONTROLLER	1 x Intel® i219LM PCIe (10/100/1000Mbps) (only Xeon, Core i7/i5 support iAMT) 1 x Intel® i211AT PCIe (10/100/1000Mbps) 2 x Intel® i211AT PCIe (10/100/1000Mbps) (opt. by request, MOQ required)
REAR I/O	ETHERNET	2 x GbE (RJ-45) 4 x GbE (RJ-45) (opt. by request, MOQ required)
	SERIAL	1 x RS-232/422/485 (RS-232 w/power (DB-9)
	USB	4 x USB 3.1 Gen 1 2 x USB 2.0
	PS/2	1 x PS/2 (mini-DIN-6)
	DISPLAY	1 x VGA 2 x DP++
	AUDIO	1 x Line-out 1 x Mic-in 1 x Line-in (opt., MOQ required)

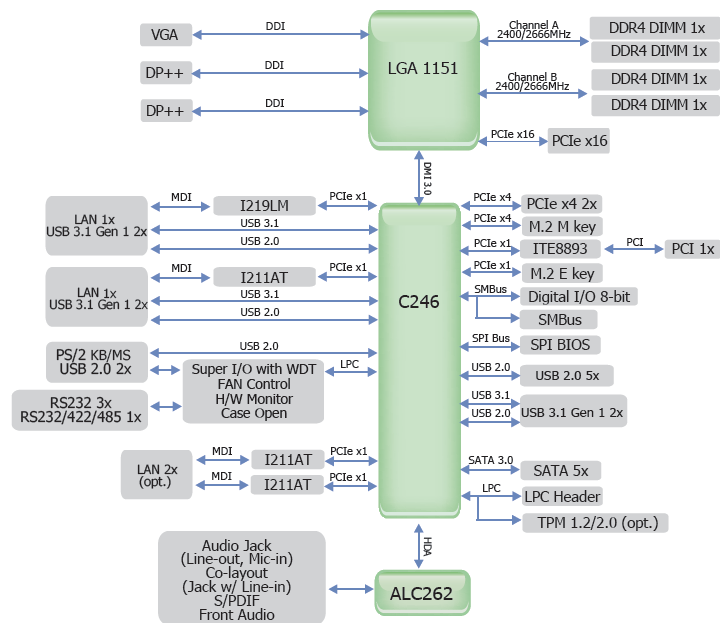
INTERNAL I/O	SERIAL	3 x RS-232
	USB	2 x USB 3.1 Gen 1 4 x USB 2.0 (2.54mm pitch) ,1 x USB 2.0 vertical Type A
	AUDIO	1 x Front Audio Header 1 x S/PDIF
	SATA	5 x SATA 3.0 (up to 6Gb/s, SATA 3) RAID 0/1/5/10
	DIO	1 x 8-bit DIO
	LPC	1 x LPC (supports LPC EXT-R5232/R5485 module)
	SMBUS	1 x SMBus
WATCHDOG TIMER	OUTPUT & INTERVAL	System Reset, Programmable via Software from 1 to 255 Seconds
SECURITY	TPM	Infineon TPM2.0/1.2 (opt., MOQ required)
POWER	TYPE	ATX
	CONNECTOR	8-pin ATX 12V power; 24-pin ATX power
	CONSUMPTION	Typical: i7-8700K: 3.3V @ 0.44A (1.452Watt); 5V @ 0.62A (3.1Watt); 12V @ 0.49A (5.88Watt) Max.: i7-8700K:3.3V @ 0.51A (1.683Watt); 5V @ 1.4A (7.0Watt); 12V @ 10.44A (128.25Watt)
OS SUPPORT	RTC, BATTERY	CR2032 Coin Cell
	MICROSOFT	Windows 10 IoT Enterprise 64-bit Windows 11 Pro 64-bit (Motherboard option with TPM/fTPM)
	LINUX	Linux
ENVIRONMENT	TEMPERATURE	Operating: -5 to 65°C Storage: -30 to 60°C with RTC Battery; -40 to 85°C without RTC Battery
	HUMIDITY	Operating: 5 to 90% RH Storage: 5 to 90% RH
	MTBF	554,887 hrs @ 25°C; 312,271 hrs @ 45°C ; 193,870 hrs @ 60°C Calculation Model: Telcordia Issue 4 Environment: GB, GC - Ground Benign, Controlled
MECHANICAL	DIMENSIONS	microATX Form Factor 244mm (9.6") x 244mm (9.6")
	HEIGHT	PCB: 1.6mm, Top Side: TBD Bottom Side: TBD
CERTIFICATIONS		CE, FCC Class B, UKCA

Dimensions





Block Diagram



Standard Services

						
Integrated Components	Revision Controlled	Fully Tested & Documented	Software Installed	Full Traceability	ISO Certified	OEM Customisation